

TOSHIBA Field-Effect Transistor Silicon N-Channel MOS Type (U-MOSIV)

SSM3K320T

High-Speed Switching Applications

- 4.5 V drive
- Low ON-resistance : $R_{on} = 77 \text{ m}\Omega$ (max) (@ $V_{GS} = 4.5 \text{ V}$)
: $R_{on} = 50 \text{ m}\Omega$ (max) (@ $V_{GS} = 10 \text{ V}$)

Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

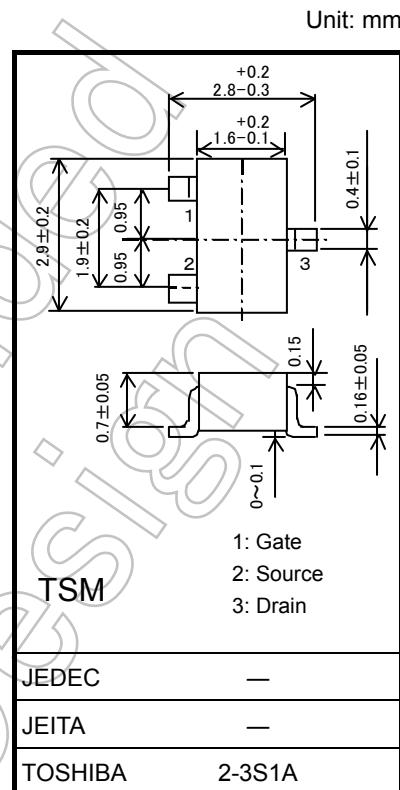
Characteristic	Symbol	Rating	Unit
Drain-Source voltage	V_{DSS}	30	V
Gate-Source voltage	V_{GSS}	± 20	V
Drain current	DC I_D (Note1)	4.2	A
	Pulse I_{DP} (Note1)	8.4	
Drain power dissipation	P_D (Note 2)	700	mW
	$t = 5\text{ s}$	1400	
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature range	T_{stg}	-55 to 150	$^\circ\text{C}$

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

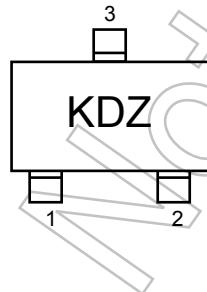
Note 1: The junction temperature should not exceed 150°C during use.

Note 2: Mounted on an FR4 board. (25.4 mm \times 25.4 mm \times 1.6 mm, Cu Pad: 645 mm 2)

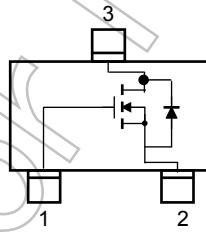


Weight: 10mg (typ.)

Marking



Equivalent Circuit (top view)



Start of commercial production
2009-07

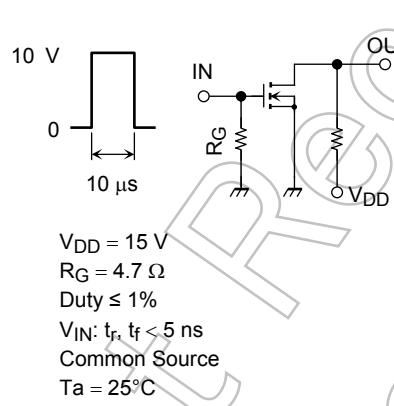
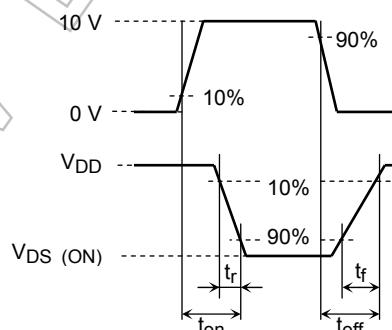
Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Conditions	Min	Typ.	Max	Unit
Drain-Source breakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0V	30	—	—	V
	V (BR) DSX	I _D = 10 mA, V _{GS} = -20 V	10	—	—	
Drain cut-off current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	—	—	10	μA
Gate leakage current	I _{GSS}	V _{GS} = ± 20 V, V _{DS} = 0 V	—	—	±0.1	μA
Gate threshold voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	1.3	—	2.5	V
Forward transfer admittance	Y _{fs}	V _{DS} = 10 V, I _D = 2.1 A (Note 3)	7.0	14.0	—	S
Drain-source ON-resistance	R _{DS} (ON)	I _D = 2.1 A, V _{GS} = 10 V (Note 3)	—	38	50	mΩ
		I _D = 2.1 A, V _{GS} = 4.5 V (Note 3)	—	58	77	
Input capacitance	C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	—	190	—	pF
Output capacitance	C _{oss}		—	65	—	
Reverse transfer capacitance	C _{rss}		—	45	—	
Total Gate Charge	Q _g	V _{DD} = 24 V, I _D = 4.2 A, V _{GS} = 10 V	—	4.6	—	nC
Gate-Source Charge	Q _{gs}		—	3.2	—	
Gate-Drain Charge	Q _{gd}		—	1.4	—	
Switching time	Turn-on time	t _{on}	V _{DD} = 15 V, I _D = 2.1 A, V _{GS} = 0 to 10 V, R _G = 4.7 Ω	—	9.0	ns
	Turn-off time	t _{off}		—	12.0	
Drain-Source forward voltage	V _{DSF}	I _D = -4.2 A, V _{GS} = 0 V (Note 3)	—	-0.90	-1.2	V

Note3: Pulse test

Switching Time Test Circuit

(a) Test Circuit

(b) V_{IN}(c) V_{OUT}

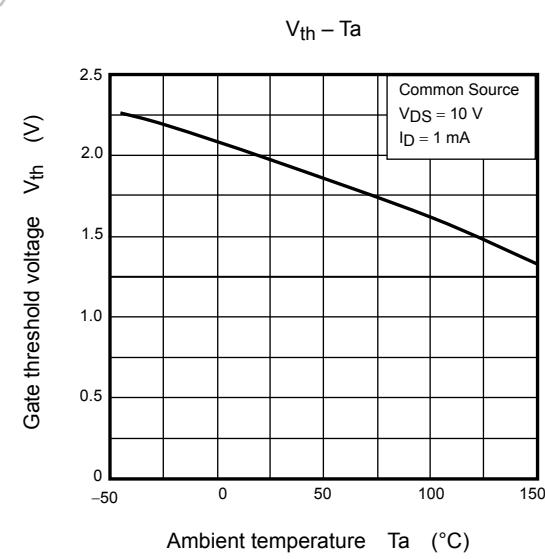
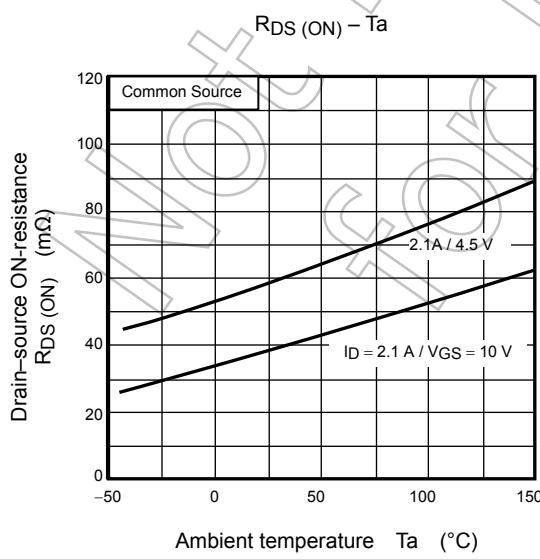
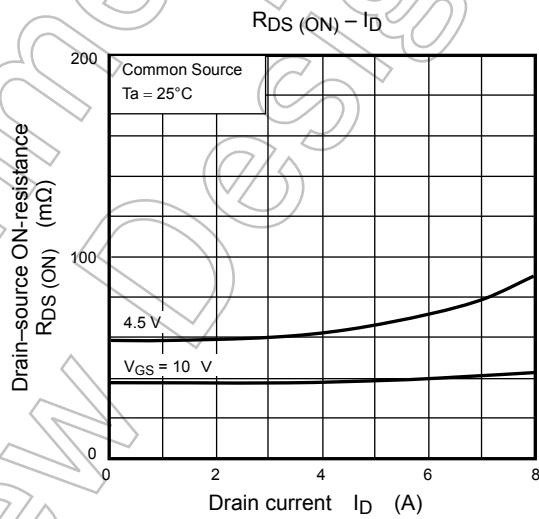
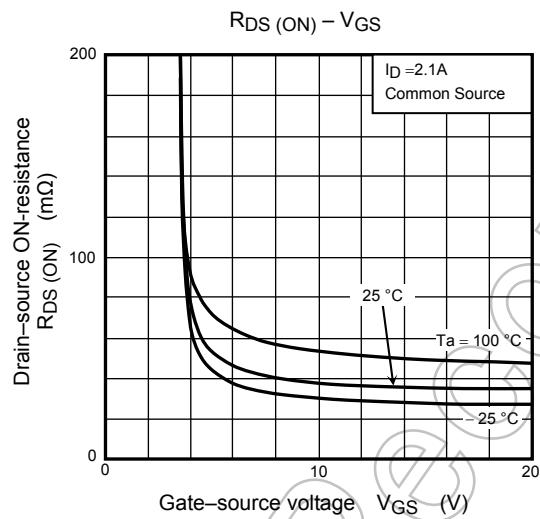
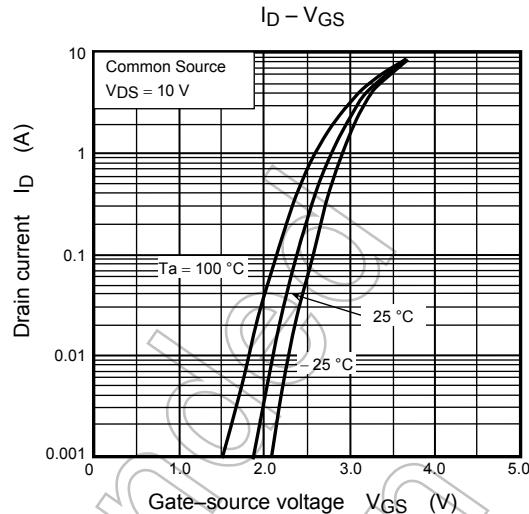
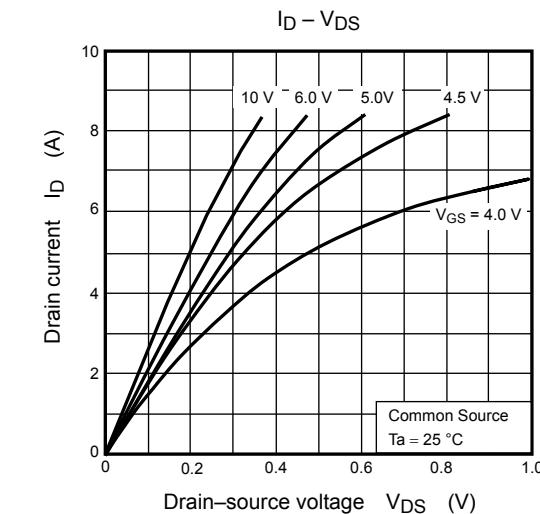
Handling Precaution

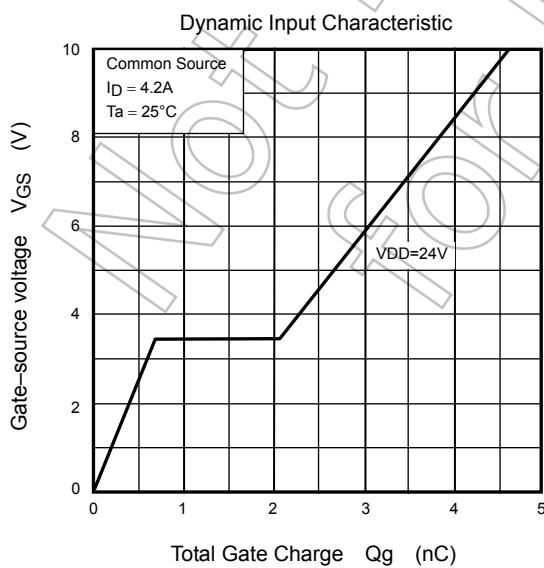
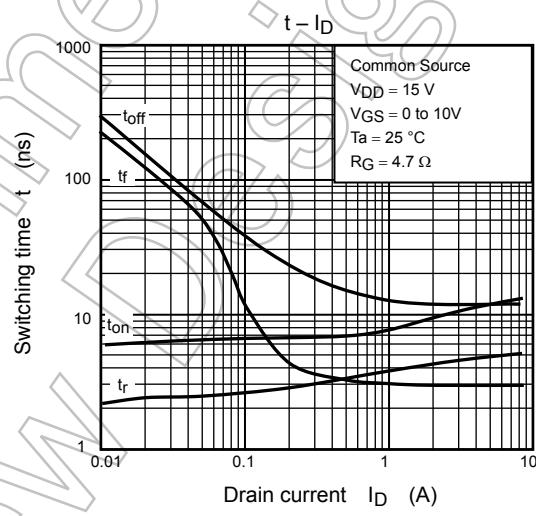
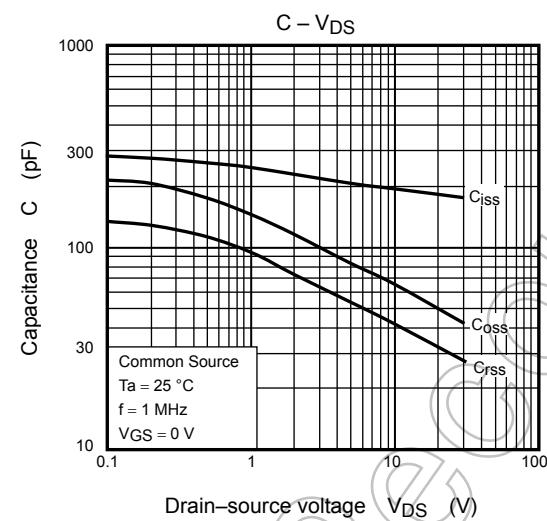
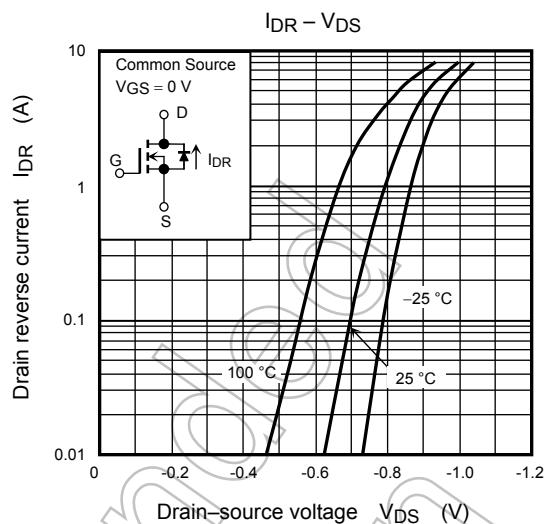
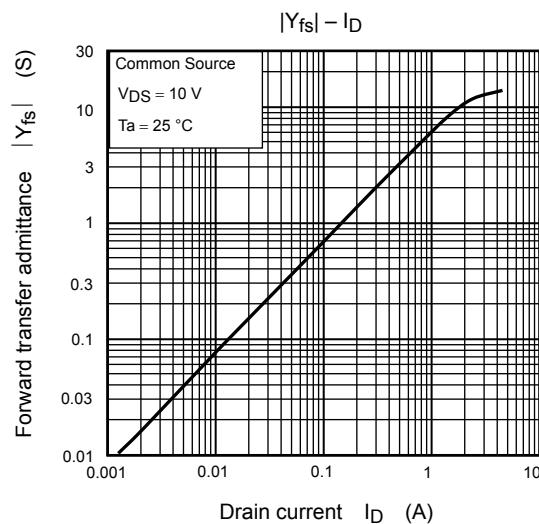
When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

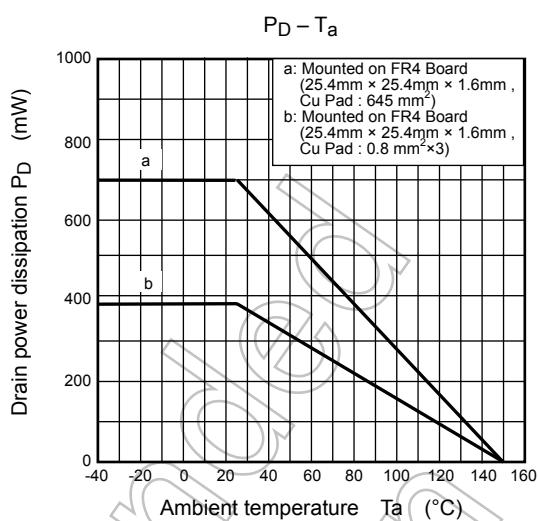
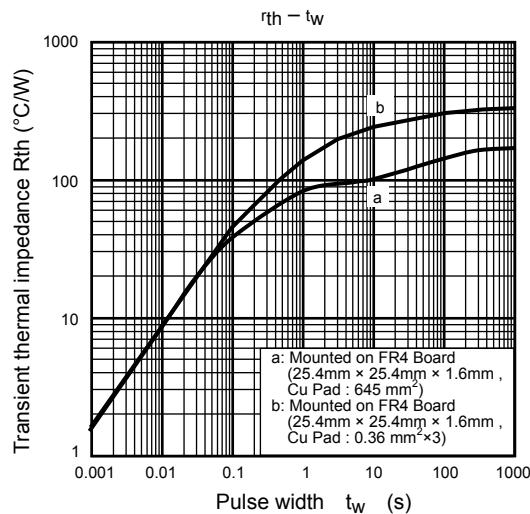
Notice on Usage

V_{th} can be expressed as the voltage between gate and source when the low operating current value is I_D = 1 mA for this product. For normal switching operation, V_{GS} (on) requires a higher voltage than V_{th} and V_{GS} (off) requires a lower voltage than V_{th}. (The relationship can be established as follows: V_{GS} (off) < V_{th} < V_{GS} (on).)

Take this into consideration when using the device.







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